

I.F.F. (Identification Friend or Foe) System

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1 Introduction

1.1 Statement of Purpose

There have been several friendly fire incidents in recorded military history, accounting for an estimated 2% to 20% of all casualties in battle^[?]. Using attire to identify friend vs enemy is problematic in situations when both sides are clad in the same camouflage pattern, or are obscured by obstacles.

The purpose of this project is to create a system that quickly and accurately identifies friendly targets among military personnel on foot. Similar systems exist for aircraft, however not many exist for infantry.

The idea is to develop a two-way communication system so that when a soldier aims their weapon in the direction of a friendly target, they will receive notification through an LED that the target is, indeed, friendly and not an enemy. Throughout this document the infantry unit with the weapon will be referred to the "friendly interrogator" and the target will be referred to as the "friendly target".

This communication protocol can be

1.2 Objectives

1.2.1 Goals and Benefits

- Reduce number of friendly fire accidents during combat ^[?]
- Reduce number of misfires accidents during combat ^[?]
- Notify friendly personnel location of particular friendly target when aiming
- Other applications including but not limited to:
 - Paintball or Airsoft
 - Arcade Laser Tag

1.2.2 Functions and Features

- Laser diode on friendly interrogator to transmit unique I.D. of friendly interrogator.
- Photodiodes on friendly target to detect unique I.D. and verify it is a valid signal.
- R.F. Transmitter on friendly target to send acknowledgement back to interrogator.
- R.F. Receiver on friendly interrogator to verify that the target is friendly.
- LED on friendly interrogator to indicate to the operator the status of the target.

2 Design

2.1 Block Diagrams and Descriptions

2.1.1 System Overview

The following figure represents the system as a whole, including both the friendly interrogator unit and the friendly target unit. Both units will be expanded upon in further detail below.

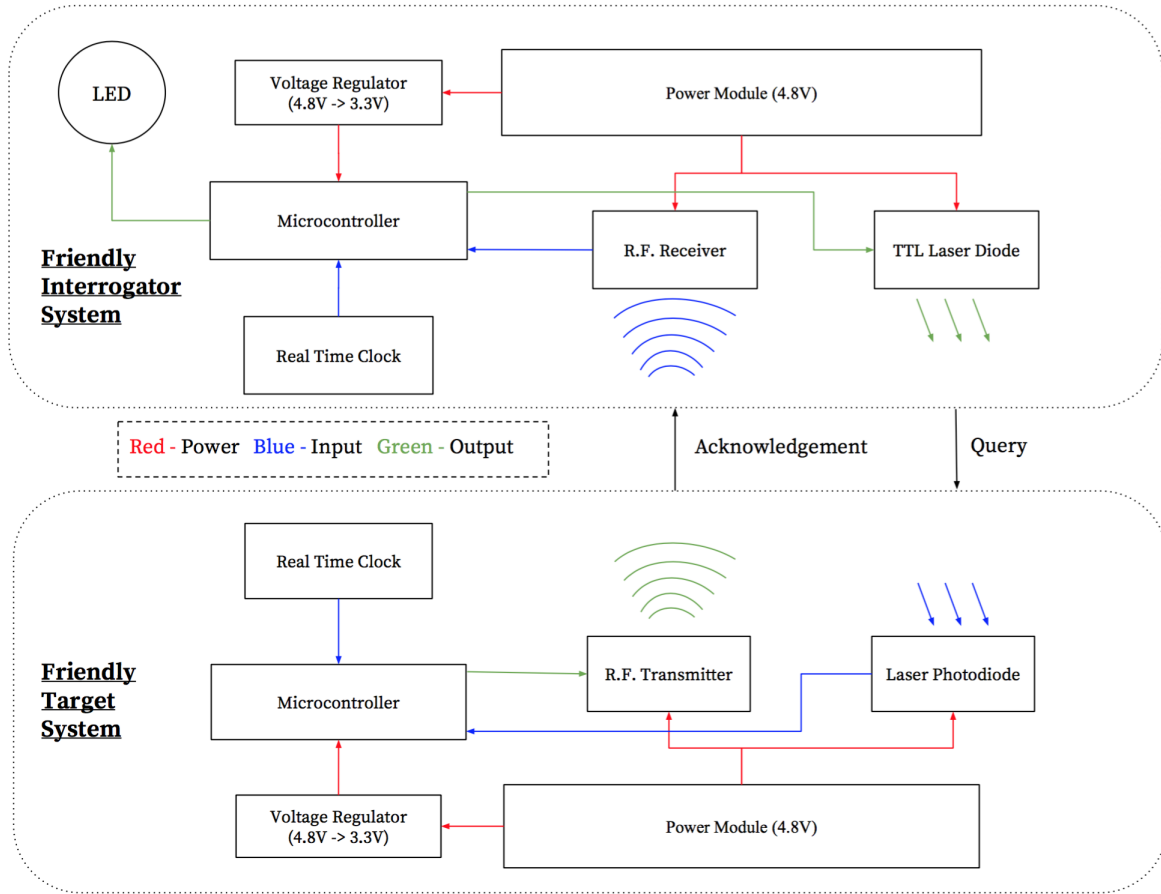


Figure 1: System Block Diagram

2.1.2 Friendly Interrogator Unit

The following diagram shows the friendly interrogator unit *only*. The interconnections in red represent power, interconnections in blue represent input to a block and interconnections in green represent output to a block. These inputs and outputs are described below under each block description.

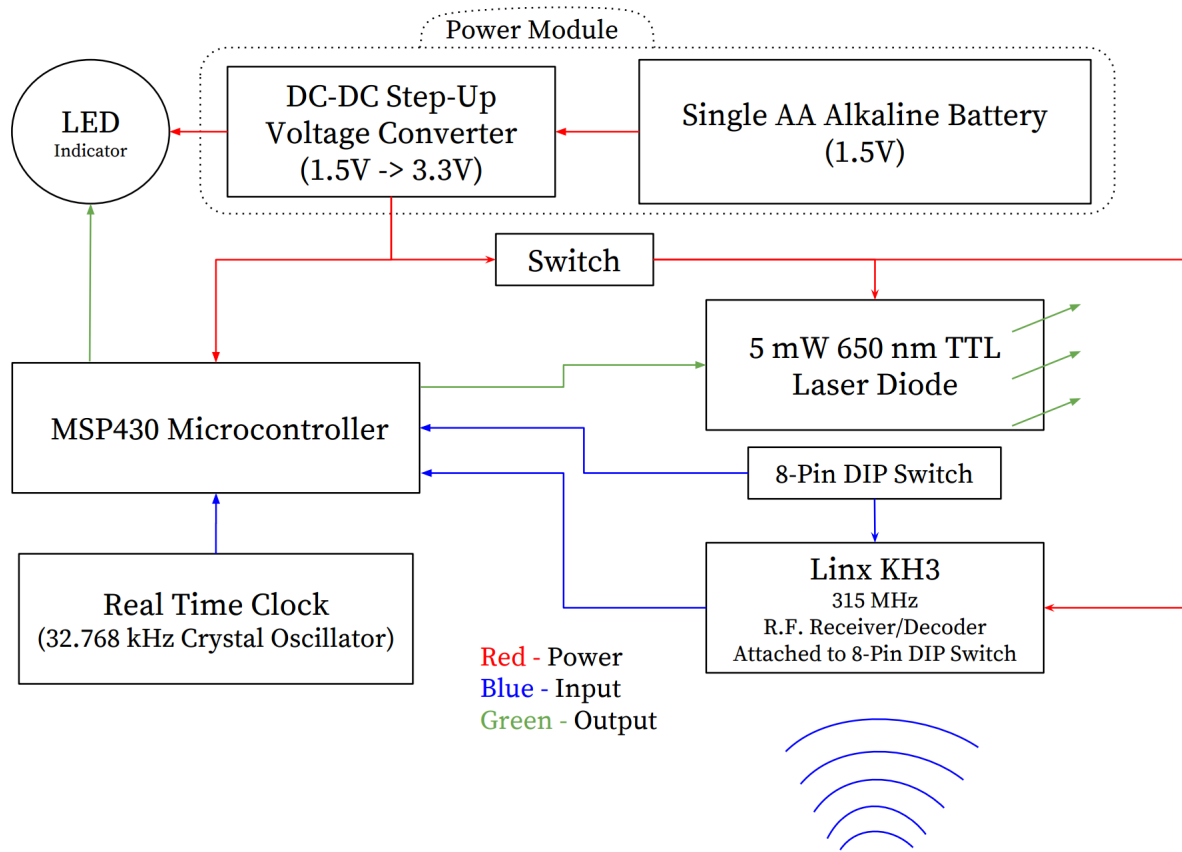


Figure 2: Block Diagram of Friendly Interrogator Unit

Power Module

Power-In, , N/A

Power-Out: MSP430 Microcontroller, 5mW Laser Transmitter, R.F. Receiver/Decoder, LED Indicator

Input(s): N/A

Output(s): N/A

The power module will consist of a single standard alkaline AA battery (no specific brand/part name is necessary) which will lead into a Skyworks AAT1217 DC-DC step-up voltage converter. This will step the voltage up to 3.3V with a maximum current output of 100 mA which is sufficient enough to power the MCU, laser transmitter, and the R.F. receiver. Please refer to Section 2.4 for these calculations regarding power delivery to this unit and resistor/capacitor/inductor part selection.

As noted on the block diagram, in between the power module and the R.F. receiver/laser transmitter, there is a switch to control the power given to these two modules. This switch exists for two reasons: (1) to decrease power consumption and (2) to limit the amount of time the laser transmitter is sending data. This design choice will be expanded upon in Section ---.

The circuit to operate the DC-DC step-up converter is shown in Figure ??.

The battery will be mounted to the PCB a standard AA through-hole PCB battery mount shown in Figure 3. However, this will be omitted from the circuit schematic for simplicity purposes. During the construction of the PCB the team will have to create the

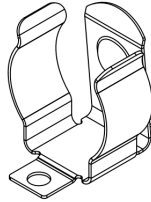


Figure 3: PCB Battery Mount

MSP430 Microcontroller

Power-In: 3.3V (from Voltage Converter Output)

Power-Out: N/A

Input(s): R.F. Receiver/Decoder Data-Out, 8-Pin DIP Switch, Real Time Clock (32.768kHz Crystal)

Output(s): LED, 5mW 650nm Laser Diode

The team chose to work with an T.I. MSP430F2274 Microcontroller Unit ^[1] due to its compiler simplicity, its availability in the ECE445 Senior Design Labs (available inventory) and the number of GPIO Pins on board (compared to other options, this model had several I/O pins and was the least expensive). Compared to many other MCUs on the market, the MSP430 is relatively well documented and there exist several support forums on the internet to assist the team throughout the duration of the project.

The board requires a 3.3V power supply to both the DV_{cc} (pin 2) and AV_{cc} (pin 16) which is why the voltage regulator is necessary as stated in the previous section.

As stated above, the input the MSP430 MCU will be the R.F. receiver/decoder signal, the 8-pin DIP switch, and the real time clock.

The R.F. receiver/decoder signal will be the acknowledgment sent from the friendly target. These outputs from the receiver/decoder will be fed into pins 20 - 27 on the MCU. This corresponds to 8 bits of data the MCU will be receiving from the friendly interrogator.

The 8-pin DIP switch, which is the unique I.D. of the friendly interrogator, will be fed into pins 31 -38 on the MCU.

The 5 mW laser will be fed into pin 17 of the MCU to control the modulation of the signal to send the unique I.D. to the friendly target.

This unique I.D. provided by the DIP switch will be used in conjunction with the output pin to the laser transmitter to create a "laser pulse" that sends the data of the I.D. to the friendly target. This will be explained in more detail in section **BLAHFUCKINGBLAH**.

Progr

The above descriptions can be summarized with Table 1 below. Each pin/label is listed with the description of the input or output. The red rows indicate that the pin is a power/ground line, the blue rows indicate

that the pin is an input *to* the MCU and the green rows indicate that the pin is an output *from* the MCU.

Pin #	Label	Description	Pin #	Label	Description
1	TEST/SBWTCK	No Connection	38	P1.7/TA2/TDO/TDI	8-Pin DIP Switch - Output 7
2	DVCC	Digital Supply Voltage	37	P1.6/TA1/TDI	8-Pin DIP Switch - Output 6
3	P2.5/R _{OUT}	No Connection	36	P1.5/TA0/TMS	8-Pin DIP Switch - Output 5
4	DVSS	Digital Ground Reference	35	P1.4/SMCLK/TCK	8-Pin DIP Switch - Output 4
5	XOUT/P2.7	32.768 kHz Crystal Oscillator (-)	34	P1.3/TA2	8-Pin DIP Switch - Output 3
6	XIN/P2.6	32.768 kHz Crystal Oscillator (+)	33	P1.2/TA1	8-Pin DIP Switch - Output 2
7	-RST/NMI/SBWTIO	No Connection	32	P1.1/TA0	8-Pin DIP Switch - Output 1
8	P2.0/ACLK/A0/OA0I0	LED Indicator	31	P1.0/TACLK/ADC10CLK	8-Pin DIP Switch - Output 0
9	2.1/TAINCLK/SMCLK/A1/OA0I1	No Connection	30	P2.4/TA2/A4/VREF-/VREF+/OA1I0	No Connection
10	P2.2/TA0/A2/OA0I1	No Connection	29	P2.3/TA1/A3/VREF-/VREF+/OA1I1/OA1I0	No Connection
11	P3.0/UCBOSTE/UCAOCLK/AS	No Connection	28	P3.7/A7/OA1I2	R.F. Receiver/Decoder - Valid Transmission Line
12	P3.1/UCBOSIMO/UCBOSDA	No Connection	27	P3.6/A6/OA0I2	R.F. Receiver/Decoder - D0 Data Line
13	P3.2/UCBOSOMI/UCBOSCL	No Connection	26	P3.5/UCABRXD/UCABOSOMI	R.F. Receiver/Decoder - D1 Data Line
14	P3.3/UCBOSCLK/UCABOSTE	No Connection	25	P3.4/UCABOTXD/UCABOSIMO	R.F. Receiver/Decoder - D2 Data Line
15	AVSS	Analog Ground Reference	24	P4.7/TBCLK	R.F. Receiver/Decoder - D3 Data Line
16	AVCC	Analog Supply Voltage	23	P4.6/TBOUTH/A15/OA1I3	R.F. Receiver/Decoder - D4 Data Line
17	P4.0/TB0	5 mW 650nm TTL Laser Transmitter - Base of NPN Transistor	22	P4.5/TB2/A14/OA0I3	R.F. Receiver/Decoder - D5 Data Line
18	P4.1/TB1	No Connection	21	P4.4/TB1/A13/OA1I0	R.F. Receiver/Decoder - D6 Data Line
19	P4.2/TB2	No Connection	20	P4.3/TB0/A12/OA0I0	R.F. Receiver/Decoder - D7 Data Line

Table 1: Pin Layout Table

Please refer to Section ?? to view in-depth discussion about the functionality of the MSP430F2274 Microcontroller Unit and how it will be used throughout this project.

Real Time Clock

Power-In: N/A

Power-Out: N/A

Input(s): N/A

Output(s): MSP430 Microcontroller

The real time clock is necessary for the verification of the acknowledgement signal sent by the R.F. transmitter on the friendly target unit. It will operate using a 32.768 kHz Crystal Oscillator (as recommended by T.I. [2]) with an accuracy of +/- 20 PPM (Parts Per Million - deviates between 32.7673 kHz and 32.7687 kHz). It will be used in conjunction with the real time clock library provided by T.I. [INSERT REFERENCE HERE](#).

Laser Diode

Power-In: 3.3V (from Voltage Converter Output)

Power-Out: N/A

Input(s): MSP430 Microcontroller Output(s): 5mW 650nm laser signal containing unique I.D. of interrogator

For safety reasons, the maximum allowable power for the laser diode is 5mW; which registers as a Class IIIa laser. The laser diode must also fall in the visible range, so that it will trigger a person's blinking reflex before eye damage occurs. Specifically, the team will use a red (650nm) laser. See section 3.2 for more on safety of the laser.

The team will use a 5 mW 650 nm TTL laser transmitter to transmit the unique I.D. (as specified by the 8-pin DIP switch) to the friendly target. This laser will operate on 3.3V at 25mA so a 1.3Ω resistor is necessary to drop the current being supplied to the diode down to this threshold.

To save cost and time, the team will be purchasing an adjustable focus laser. This laser will allow for optical adjustments to achieve the beam diameter at all required distances. The team will ensure the purchased laser meets these requirements, and will adjust the lens if necessary.

R.F. Receiver/Decoder

Power-In: 3.3V (from Voltage Converter Output)

Power-Out: N/A

Input(s): 8-Pin DIP Switch

Output(s): MSP430 Microcontroller

A Linx 315 MHz KH3 Series R.F. Receiver/Decoder will be used for this project along with a Linx 315-SP Splat PCB Mounted Antenna. Some important values that were used in the selection process of this part are listed in Table 2

Parameter	Typical Value
Operating Voltage	3.3V
Supply Current	5.9mA
Receiver Frequency	315 MHz
Receiver Sensitivity	-116 dB
R.F. Input Impedance	50 Ω
Datarate	100 bps - 10,000 bps
Receiver Turn-On Time	7.0 ms

Table 2: Linx 315 MHz KH3 R.F. Receiver

Important values to note are the R.F. input impedance, the receiver frequency, and the receiver sensitivity. The input impedance is stating it requires the entire R.F. receiver system to be matched at 50 Ω . This requires the trace on the PCB from the receiver to the antenna to also be at a 50 Ω impedance. The frequency and sensitivity affect the range of the receiver/transmitter pair and this calculation along with the PCB trace-width calculation can be found in Section 2.4.

The decoder provides very important functionality and simplicity to the system. There are a total of 10 address lines on the decoder that must match up to the cooresponding transmitting encoder. The lines do not output data through the data-out lines if the address lines do not match up. The team decided to make use of these lines and wire them up to a 8-pin DIP switch so that the operator can choose their unique interrogator I.D. Therefore only 8 out of the 10 address lines on the encoder will be used and the top two most significant bits will be grounded (lines A9 and A10).

As stated before this identification number will be fed into the MCU also and it will determine what the 5mW laser transmitter will send out to the friendly target. This process will be explained in Section ??.

2.1.3 Friendly Target Unit

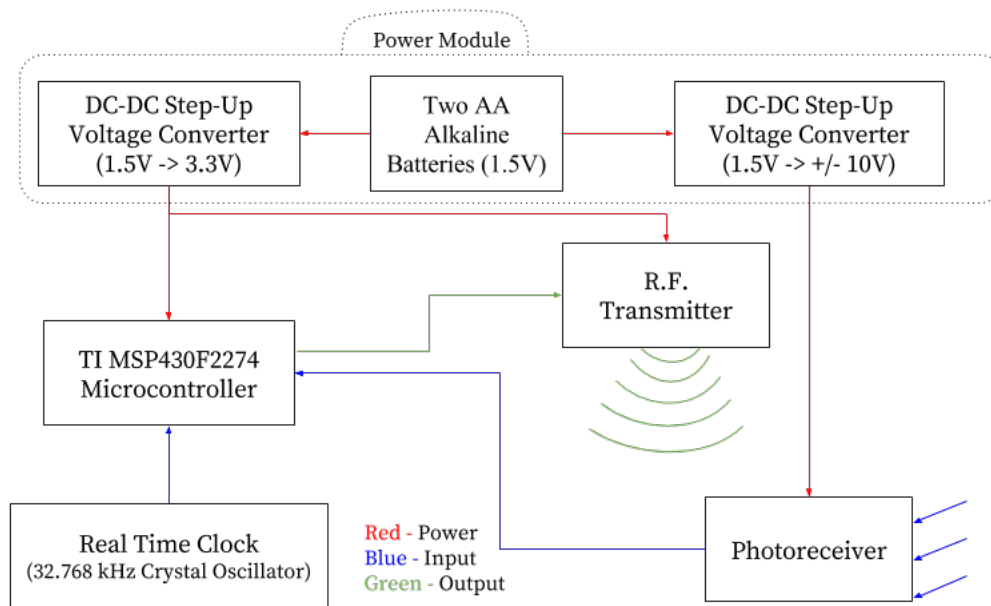


Figure 4: Block Diagram of Friendly Target System

Power Module

Power-In: N/A

Power-Out: TI MSP430F2274 Microcontroller (3.3V), R.F. Transmitter (3.3V), and Photoreceiver (+/- 10V)

Input(s): N/A

Output(s): N/A

The power module on board will utilize the same DC-DC Step-Up Voltage Converter as the friendly interrogator unit. However, the friendly target unit's power module must produce both an output voltage of 3.3V for the MCU and 10V for the operational amplifier.

MSP430 Microcontroller

Power-In: Power Module (3.3V)

Power-Out:

Input(s): Photoreceiver, Real Time Clock

Output(s): R.F. Transmitter

Please reference the MSP430 Microcontroller section on board the Friendly Interrogator Unit for details on the selection of the MSP 430.

The MSP430 Microcontroller on the Friendly Target Unit will receive input from the photoreceiver unit, which will allow it to register the PWM signal sent from the Friendly Interrogator Unit. The Microcontroller will also utilize the R.F. Encoder/Transmitter to broadcast an acknowledge signal to the Friendly Interrogator Unit.

The R.F. Transmitter takes as input 8 address bits and 8 data bits. The PWM laser signal from the Friendly

Interrogator will contain the 8 address bits corresponding to the Interrogator's R/F decoder/receiver. The 8 data bits will be generated based on a shared passcode and RTC between the Friendly Target and Interrogator systems.

Figure 3 is a list of the active pins on the Friendly Target MCU.

Pin #	Label	Description	Pin #	Label	Description
1	TEST/SBWTCK	No Connection	38	P1.7/TA2/TD0/TDI	R.F. Transmitter A0
2	DVCC	Digital Supply Voltage	37	P1.6/TA1/TDI	R.F. Transmitter A1
3	P2.5/Rosc	No Connection	36	P1.5/TA0/TMS	R.F. Transmitter A2
4	DVSS	Digital Ground Reference	35	P1.4/SMCLK/TCK	R.F. Transmitter A3
5	XOUT/P2.7	32.768 kHz Crystal Oscillator (-)	34	P1.3/TA2	R.F. Transmitter A4
6	XIN/P2.6	32.768 kHz Crystal Oscillator (+)	33	P1.2/TA1	R.F. Transmitter A5
7	-RST/NMI/SBWDIO	No Connection	32	P1.1/TA0	R.F. Transmitter A6
8	P2.0/ACLK/A0/OA00	No Connection	31	P1.0/TACLK/ADC10CLK	R.F. Transmitter A7
9	P2.1/TA1CLK/SMCLK/A1/OA00	Photodiode #1	30	P2.0/TA2/A4/VREF-V4REF/OA10	Photodiode #4
10	P2.2/TA0/A2/OA01	Photodiode #2	29	P2.3/TA1/A3/VREF-V4REF-OA11/OA10	Photodiode #3
11	P5.0/UCB0STE/UCACLK/A5	R.F. Transmitter D0	28	P5.7/A7/OA112	R.F. Transmitter D7
12	P5.1/UCB0S0M/UCB0SDA	R.F. Transmitter D1	27	P5.6/A6/OA012	R.F. Transmitter D6
13	P5.2/UCB0S0M/UCB0SCL	R.F. Transmitter D2	26	P5.5/UCB0R0M/UCB0S0M	R.F. Transmitter D5
14	P5.3/UCB0CLK/UCB0STE	R.F. Transmitter D3	25	P5.4/UCB0R0M/UCB0S0M	R.F. Transmitter D4
15	AVSS	Analog Ground Reference	24	P4.7/TBCLK	No Connection
16	AVCC	Analog Supply Voltage	23	P4.6/TBOUTH/A15/OA113	No Connection
17	P4.0/TB0	R.F. Transmitter TE	22	P4.5/TB2/A14/OA013	No Connection
18	P4.1/TB1	No Connection	21	P4.4/TB1/A13/OA10	No Connection
19	P4.2/TB2	Clock Reset	20	P4.3/TB0/A12/OA00	No Connection

Table 3: Pin Layout Table

Real Time Clock

Power-In:

Power-Out:

Input(s):

Output(s):

The Real Time Clock on board the Friendly Target Unit will be the same as the Friendly Interrogator Unit. Please reference that section to get all details pertaining to the Real Time Clock.

Photoreceiver

Power-In: N/A

Power-Out: N/A

Input(s): Laser Transmitter

Output(s): MCU

A network of four photodiodes mounted on the friendly target will report incoming laser signals to the MCU. The photodiode signals will be boosted via an operational amplifier, and passed through a low-pass filter. The $40kHz$ signal that passes through the filter will be sampled and processed by the MCU.

For a detailed analysis of the choice of the photodiodes, see section 3.1

R.F. Transmitter

Power-In:

Power-Out:

Input(s):

Output(s):

A Linx 315 MHz LR Series R.F. Transmitter will be used for this project along with a Linx 315-SP Splatch PCB Mounted Antenna. This is an identical setup to the receiver end on the friendly interrogator unit as discussed before.

Parameter	Typical Value
Transmit Frequency	315 MHz
Output Power	4 dB
Data Rate	10,000 bps
R.F. Output Impedance	50 Ω
Transmitter Turn-On Time	1.0 ms

Table 4: Notable Datasheet Values for Linx 315 MHz LR R.F. Transmitter

2.2 Circuit Schematics

2.2.1 Friendly Interrogator Unit

The circuit schematic is shown below for the Friendly Interrogator Subsystem. **INSERT OVERALL CIRCUIT SCHEMATIC HERE**

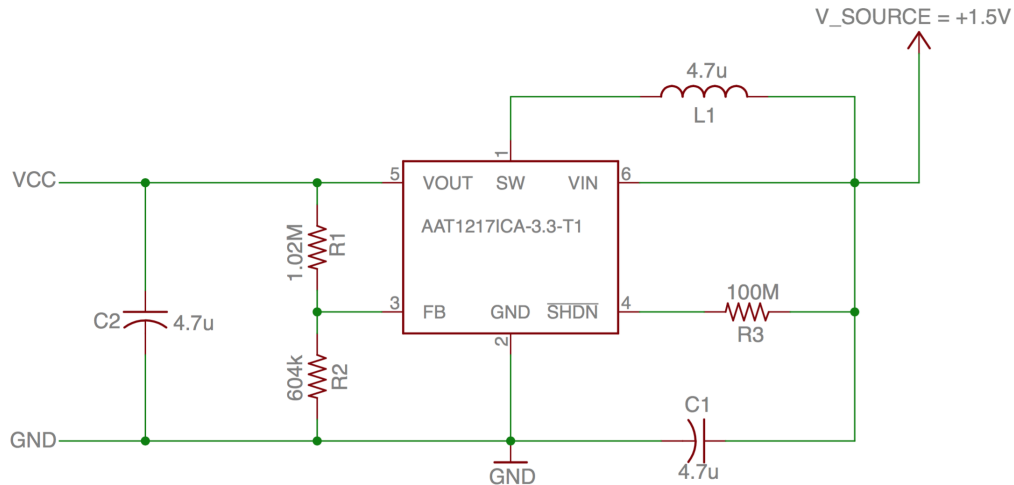


Figure 5: AAT1217 Circuit Schematic

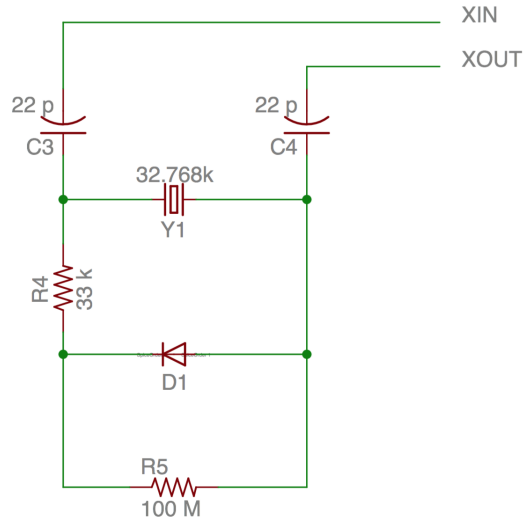


Figure 6: Crystal Oscillator Real Time Clock Circuit Schematic

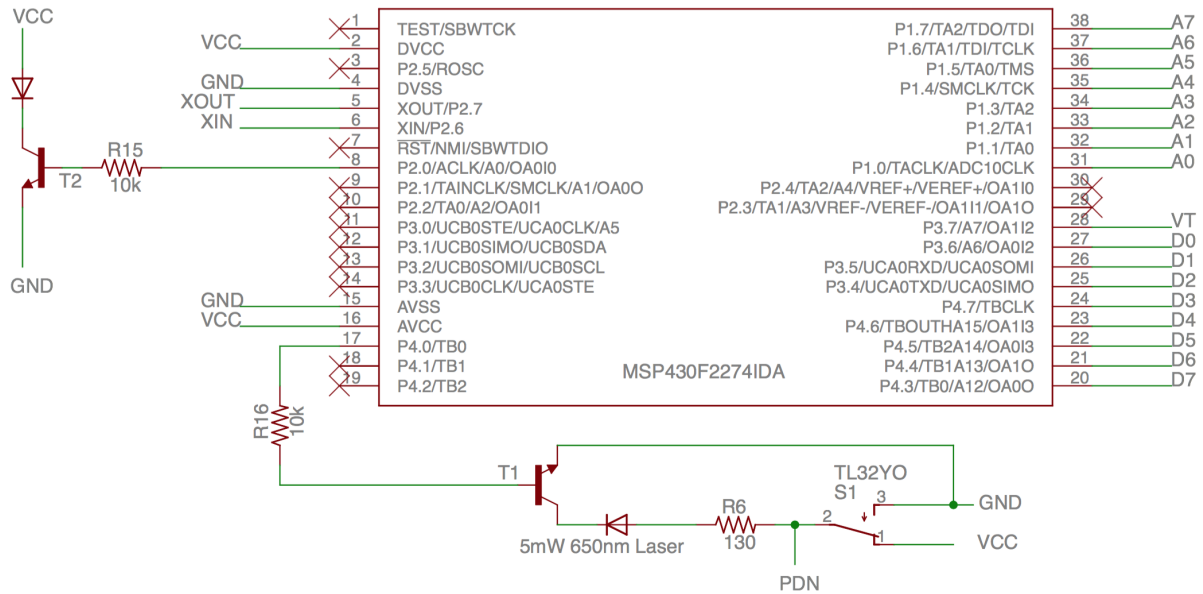


Figure 7: MCU and Laser Transmitter Circuit Schematic

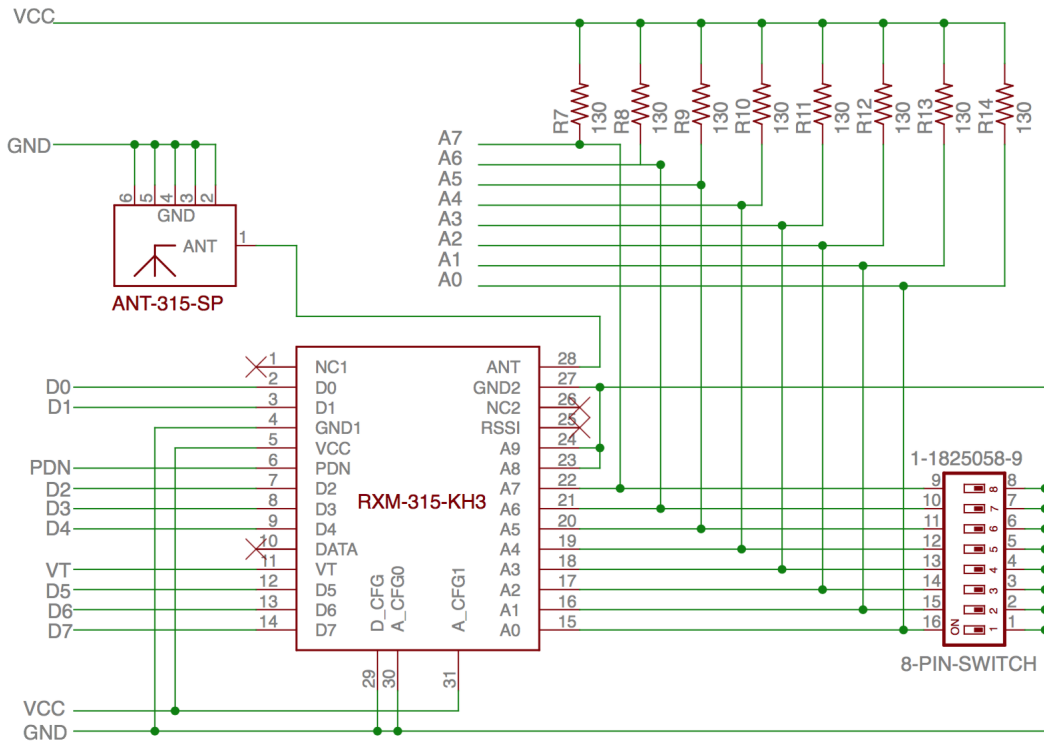


Figure 8: RF Receiver/Decoder and 8-Pin DIP Switch Schematic

2.2.2 Friendly Target Unit

2.3 Software Flowcharts / Functionality

2.3.1 System Flow

This section is to explain the flow of events in the system as a whole as well as each the friendly interrogator subsystem and the friendly target subsystem. The below diagram is a flowchart representing the events that occur to identify a target as friendly.

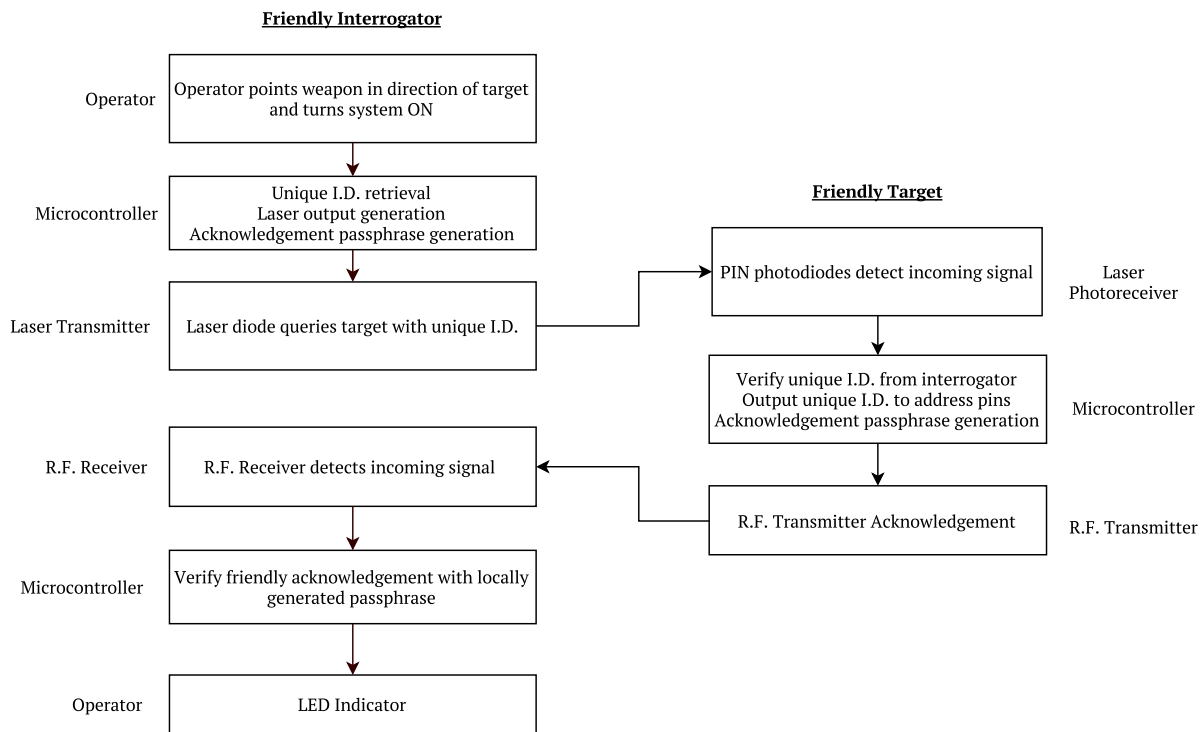


Figure 9: Flowchart for Functionality

The left side of this diagram are all events that occur within the friendly interrogator unit, and the right side represents all of the events that occur on the friendly target side. This flow diagram also assumes that both the interrogator operator and the friendly target operator have powered on their respective units.

2.3.2 Friendly Interrogator Software Flow

The software on the MCU on the friendly interrogator unit will follow a very simple flow utilizing basic concepts of microcontrollers including timer, interrupts, i/o and basic logic and arithmetic. The MSP430F2274 contains 16 registers of which 4 are protected and 12 are general purpose registers:

- R0 - program counter
- R1 - stack pointer
- R2 - status register
- R3 - constant generator
- R4 - R15 - general purpose registers

Using these 12 general purpose registers the team can accurately identify a target as friendly. The flow diagram in Figure 13 in the Appendix depicts the series of processes and events that take place within the MCU in order for the target to be identified as friendly.

2.4 Numerical Analysis and Simulations/Plots

2.4.1 Calculations

Power Module (Friendly Interrogator Unit)

The following section is intended to backup the design choices made for the power module on the friendly interrogator first shown in section 2.1.2.

The team placed a strict requirement (shown in section ---) regarding the operation time of the friendly interrogator unit (at 8 hours of operation time $\pm 5\%$ **verify**).

In order to select parts that satisfied this requirement, the active current consumption on the entire unit must first be calculated. The main power consumption modules on board the friendly interrogator unit are the MSP430F2274, the 5mW 635nm TTL laser transmitter, and the Linx KH3 R.F. receiver. These values were received from each of the respective datasheets. The following table displays the active current consumption of each unit.

Module	Active Current Consumption	Standby Current Consumption
MSP430	270 μA	0.1 - 0.7 μA
Linx KH3 R.F. Receiver	5.9 mA	0 mA
5 mW Laser	25 mA (max)	0 mA

Table 5: Notable Datasheet Values for Linx 315 MHz LR R.F. Receiver

Because the R.F. receiver and the 5mW laser will only be powered when the operator designates, the standby current consumption of these units will be 0.

Therefore, with this information, the maximum possible active current consumption will be:

$$\text{Active Consumption } I_{\text{Total}} = 270\mu A + 25mA + 5.9mA = 31.17mA$$

Assuming the team uses a standard Alkaline AA 1.5V Battery, these typically produce anywhere from 1800mAh to 2500 mAh **insert reference here**. Therefore, the average of these two values will be used as the capacity of the battery: 2150 mAh. Since all of the components being used requires 3.3V, this battery must be fed into a voltage step-up converter as stated previously. The team is using the AAT1217 step-up converter this boosts the voltage up from 1.5V to 3.3V with a 75% efficiency **insert reference here**.

Using energy conservation laws, the equivalent capacity can be determined after stepping this voltage up from 1.5V to 3.3V. Since Energy = Power * time, we can use a ratio of the energy produced per hour of the standard alkaline battery to the output voltage of the converter. This calculation can be shown below:

$$\begin{aligned} \text{TotalCapacity} &= \frac{P_{\text{battery}} * \text{time} * V_{\text{battery}}}{V_{\text{converter-output}}} * \text{ConverterEfficiency} \\ \text{TotalCapacity} &= \frac{2150mAh * 1.5V}{3.3V} * 75\% = \left(\frac{732.95mAh}{31.17mA} \right) = \mathbf{23.5 \text{ hr active use}} \end{aligned}$$

This result shows that a single standard alkaline AA 1.5V disposable battery will be more than sufficient enough to satisfy the requirements of 8 hours of active use time.

Antenna-to-Receiver and Antenna-to-Transmitter PCB Impedance Matching

The input impedance of both the Linx R.F. receiver, transmitter and antenna are all 50Ω . Therefore, in order to match this impedance on the line that goes from the receiver/transmitter chip to the antenna chip, the width must be calculated on the PCB trace.

Figure 10 shows all variables that affect the impedance of a PCB trace.

T = trace thickness (in mils)
 W = trace width (in mils)
 H = height of substrate (in mils)
 ϵ = dielectric constant of material

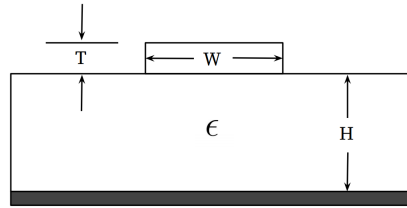


Figure 10: PCB Microstrip Impedance Variables

The equation to calculate the impedance is as follows:

$$Z = \frac{Z_0}{2\pi\sqrt{2}\sqrt{\epsilon+1}} * \ln \left(1 + 4 * \frac{H}{w_{eff}} * (X_1 + X_2) \right)$$

where

$$W_{eff} = W + \left(\frac{T}{\pi} \right) * \ln \left\{ \frac{4 * e}{\sqrt{\left(\frac{T}{H} \right)^2 + \left(\frac{T}{W * \pi + 1.1 * T * \pi} \right)^2}} \right\}$$

$$X_1 = \frac{4 * (14 * \epsilon + 8)}{11 * \epsilon} * \left(\frac{H}{W_{eff}} \right)$$

$$X_2 = \sqrt{16 * \left(\frac{H}{W_{eff}} \right)^2 * \left(\frac{14 * \epsilon + 8}{11 * \epsilon} \right)^2 * \left(\frac{\epsilon + 1}{2 * \epsilon} \right) * \pi^2}$$

The ECE parts shop uses 1 oz copper trace and FR4 board material as its substrate [insert reference](#). Assuming these properties have not changed at the time of this design review, then the following values can be used for T , H , Z , Z_0 and ϵ :

Z_0 = impedance of free space $\approx 120 \pi \Omega$

T = 1.4mils

H = 1.6mm

ϵ = 1.4

Z = 50Ω

The result after plugging in each respective value and solving for W, is that the PCB trace must be **3.23 mm** wide going from each R.F. module to the antenna.

R.F. Transmitter/Receiver Range

The range of the R.F. transmitter and receiver is required to reach a distance of 300 meters. The range in kilometers is a function of the following variables:

P_T = Transmitter Power (dBm)

A_g = Total Antenna Gain (dB)

C_l = Connection Loss (dB)

G_{tot} = Total Gain (dB)

R = Receiver Sensitivity (dBm)

L = Transmission Path Loss (dB)

f_{MHz} = Frequency in MHz

Transmission Path Loss is the sum of all the antenna R.F. gains and deduction of all possible losses. Assuming a perfect system on the ground without any interference the following equation can be used to calculate the path loss in a transmission:

$$L = P_T + (A_g - C_l)$$

This equation can be used in conjunction with the following equation to calculate the total range in kilometers:

$$d_{TX \rightarrow RX} = 10^{\left(\frac{L - 32.45 - 20 \cdot \log(f_{MHz})}{20}\right)}$$

The following values were used in this range calculation:

$$P_T = +4\text{dBm}$$

$$A_g = 2.15 \text{ dBi (quarter-wave monopole)}$$

$$C_l = 0 \text{ dB}$$

$$G_{tot} = 2.15\text{dB}$$

$$R = -116 \text{ dBm}$$

$$L = 120.15$$

Plugging in these values to the equation stated before, the team received a range of **77.03 km** which well surpasses the requirements of 300 m.

Power Module (Friendly Target Unit)

Laser Diode

Put lens equations, ref tolerance analysis

2.4.2 Simulations/Plots

INSERT PLOTS/ANY SORT OF ANALYSIS HERE

3 Requirements and Verification

UPDATE THIS TABLE-maybe reference an appendix in the back?

Block/Subsystem	Module	Requirement	Verification
Friendly Interrogator System: Laser Transmitter	Laser Diode	Must be able to achieve 5 mW of power at source with a wavelength in the visible light spectrum from 620-750 nm (red). Light from the beam must span a range of 10-15 inches at the following distances, with optical adjustments allowed: - Short Range (50 m) - Medium Range (150 m) - Long Range (300 m)	Verify with multimeter that the laser is producing 5 mW at source. Verify the laser is in the visible light spectrum from 620-750nm using a Field Test - Verify laser transmission at distances for three ranges.
	Power Module	Must maintain a constant DC power source of $4.8V \pm 5\%$. Must be able to supply 4.8V for a period of 8 hours $\pm 5\%$.	Attach power module to digital multimeter in parallel and measure output voltage with and without load components attached. Attach power module to digital multimeter in parallel and measure output voltage over a period of time.
	Voltage Regulator	Must be able to output a constant voltage of 3.3V with $\pm 0.3V$ deviation (i.e. $3.27V < V_{out} < 3.33V$), with a current supply of max 75mA.	Attach power module to digital multimeter in parallel and measure output voltage with and without load components attached.
	Real Time Clock (RTC)	Must oscillate at a frequency of 32.768 kHz with a precision of ± 20 PPM.	Attach oscilloscope to outputs of crystal oscillator circuit and measure frequency
	Microcontroller (MCU)	Ability to control laser transmitter to send digital data at a frequency of at least 30 kHz. Must maintain its own internal clock to a precision of ± 10 minutes $\pm 10\%$.	Verify using oscilloscope connected to output generated by MCU and measuring period time in μs . Sample packets sent to microcontroller and verify time with that of a local known source.

Figure 11: Requirements/Verification for Laser Transmitter System

3.1 Tolerance Analysis

The inherent limitations of laser power for safety means that the performance is in the hands of the photodiode. The starting point for selection criteria was to choose a photodiode type. There are three main photodiode types: normal, PIN, and Avalanche; the team chose PIN photodiodes as they have a high sensitivity and speed. A normal photodiode would not be sensitive enough to register a wide divergence 5mW laser, and an Avalanche photodiode requires high voltage.

The next selection criteria is the material with which the photodiode is made. This includes materials such as Si, InGaAs, and InA. The optimum wavelength is dependent on the material selection.

With photodiodes, Noise-equivalent Power (NEP) is a measure of the incident power required to generate a response signal equal to the noise level of a detector system. Detectivity is the reciprocal of the NEP normalized for the active area of the photodiode.^[7] The best photodiode, then, will have the highest detectivity for the visible wavelength.

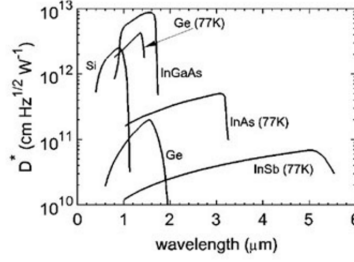


Figure 12: Specific Detectivity for Photodiode Materials [?]

Figure 12 illustrates the specific detectivity ranges of photodiodes. The interrogation laser is in the visible range; therefore, the matching photodiode is of type Si. Using this type of photodiode, the detectivity is between 10^{10} and $10^{13} \frac{Hz^{\frac{1}{2}}}{W}$. The following calculations will use a conservative value, $10^{12} \frac{Hz^{\frac{1}{2}}}{W}$, as the detectivity. In reality, because the wavelength is less than $1 \mu m$, the detectivity is somewhere between 10^{12} and $10^{13} \frac{Hz^{\frac{1}{2}}}{W}$.

The equation for NEP from detectivity, D^* , and photodiode active area, A , is

$$NEP = \frac{\sqrt{A}}{D^*} \left[\frac{W}{Hz^{1/2}} \right]$$

The incident irradiance, E_i , to cancel noise is

$$E_i = \frac{NEP \cdot \sqrt{f}}{A} = \frac{\sqrt{A} f}{AD^*} = \frac{f}{D^* \sqrt{A}} \left[\frac{W}{m^2} \right]$$

The NEP measures the incident irradiance to cancel the noise on the photodiode. To register a signal on the MCU, the incident irradiance must be higher than the noise. To be conservative, define the required incident irradiance as

$$E_{req} = 2E_i \left[\frac{W}{m^2} \right]$$

Multiplying the area of the laser's spot by the required incident irradiance at the photodiode gives the necessary power. Thus, the radius of the spot in terms of the power of the laser and required incident irradiance at the photodiode is

$$r = \sqrt{\frac{P}{\pi E_{req}}} [m]$$

Note that the power contained in the laser's spot does not depend on distance from the source, as atmospheric reflection is negligible at $300m$.

The radius, in terms of the detectivity, frequency, and sensor active area is

$$r = \sqrt{\frac{PD^* \sqrt{A}}{2\pi f}} [m]$$

The proposal listed $0.8382m$ as the ideal radius of the laser's spot. Unfortunately, with the $5mW$ red laser, this would require a sensor with a massive active area. The largest sensor the team could find, at a reasonable price, has a $100mm^2$ active area.

For the $100mm^2$ active area photodiode operating at $650nm = 4.6121910^{14}Hz$

$$r = 0.608721m \approx 61cm$$

Refining the proposal requirements, the team has set a new requirement of a $50cm$ laser spot radius, making the diameter of the beam $1m$ at distances of $50m$, $150m$, and $300m$ with optical adjustment.

Capturing these requirements, the team must transmit a signal to a photo-detector at the following ranges:

- Short Range (0 - 50 m)
- Medium Range (50 - 150 m)
- Long Range (150 - 300 m)

The team should then verify that the signal was received. Furthermore, the team should verify that the signal spans the width of a human chest. More concretely, that a sighted-in laser transmitter can be aimed at any point within $50cm$ of the receiver and still register the transmitted signal.

Test Procedure:

- Mount the receiver 300 m downrange of the transmitter
- Aim the laser transmitter directly at the receiver, using a mount (like a vice grip) to keep it stable.
- Verify the signal is received via the probe point on the PCB
- Aim and verify the signal is also received when aiming 25 cm to the right, top, and bottom of the receiver.
- Repeat these steps for 50 m and 150 m.

3.2 Safety

Laser Safety

To achieve the laser beam diameter at $300m$ associated in the proposal, a Class 3B laser would be required. In the State of Illinois, a Class 3B laser must be registered with the Division of Nuclear Safety in the Illinois Emergency Management Agency. The 3B laser would also present a significant viewing hazard; especially in an application where the laser is intended to be pointed at people.

For the reasons stated above, the team will instead use a $5mW$ visible red laser. $5mW$ visible lasers have a low chance of injuring the eye, as the blinking reflex will save a victim from permanent damage; as opposed to IR lasers which can go unnoticed for several seconds.

The following is a calculation for the nominal ocular hazard distance (NOHD) of the laser, as defined by the ANSI Standard [3].

The maximum permissible exposure (MPE), as defined by the ANSI Standard [3] is the highest power or energy density of a light source that is considered safe, i.e. that has a negligible probability for creating damage. This MPE for a pulsing laser is calculated as the minimum of the following three rules:

1. Any single pulse in the train must not exceed the MPE for the pulse exposure time.
2. The exposure from any group of pulses delivered in time T must not exceed the MPE for time T, where T is 0.25 seconds (from the blinking reflex), for a visible laser.
3. For thermal injury, the exposure for any single pulse within a group of pulses must not exceed the single-pulse MPE multiplied by a multiple-pulse correction factor

The laser will pulse at a rate of $40kHz$. Assuming at most a 50% duty cycle, each pulse will be of max length $1.25 * 10^{-5}s$. The divergence of the beam is smallest for the longest range; a lower divergence is more restrictive in terms of safety, so this calculation uses $300m$.

At $5mW$ with a pulse width of $1.25 * 10^{-5}$, the power of the laser is $6.25 * 10^{-8}J$.

ANSI defines several constants for use in the calculation of laser safety. The relevant constant for these calculations is the constant C_6 . This is defined as

$$C_6 = \frac{\theta}{1.5} \text{ for } 1.5 \leq \theta \leq 100$$

$$C_6 = 1 \text{ for } \theta < 1.5, \theta > 100$$

Using trigonometry, the divergence angle, θ , for the laser is

$$\tan^{-1}\left(\frac{r}{300}\right) * 1000 \text{ [mrad]}$$

Following the ANSI Standard [3], the Rule 1 calculation is

$$R_1 = 5 * 10^{-3} * C_6$$

The Rule 2 calculation is

$$R_2 = 18(T)^{0.75}$$

The Rule 3 calculation is

$$R_3 = R_1(T * f)^{0.25}$$

The most restrictive rule defines the MPE

$$MPE = \min(R_1, R_2, R_3)$$

The MPE, then, is
 $\min($

$$\begin{aligned} & 5 * 10^{-3} * \tan^{-1}\left(\frac{.5}{300}\right) * 1000 \\ & 18(.25)^{0.75} \\ & 0.00833333(0.25 * 40000)^{0.25} \end{aligned}$$

)

This gives

$$MPE = \min(0.00833333, 6.36396, 0.0833333) = 0.00833333 \left[\frac{J}{m^2} \right]$$

The NOHD is defined as (with θ in terms of rad , not $mrad$)

$$\frac{\sqrt{\frac{4 * P}{\pi * MPE}} - 2w}{\theta}$$

Where P is the power of the beam ($6.25 * 10^{-8} J$) and w is the waist of the beam, $0.5mm$. This gives an NOHD of

$$\frac{\sqrt{\frac{4 * 6.25 * 10^{-8}}{\pi * 0.00833333}} - 2 * 0.0005}{\tan^{-1}\left(\frac{.5}{300}\right)} = 1.25m$$

The team will take precautions to avoid eye contact with the laser within $1.25m$ of the source. If it is absolutely necessary to work with the laser powered on and a person within $1.25m$ of the laser, the person will be required to wear protective eye wear.

The risk of eye damage is mitigated by the fact that the laser is both visible, and not always powered on.

Electrical Safety

The majority of the components operate at less than $5V$, which does not present a significant risk. Two components, however, operate with a voltage differential of $20V$. This is the $5V$ to $10V$ converter and the Operational Amplifier used for the photoreceiver. The team will exercise caution when working with these units; using a multimeter to verify the part is powered off before making contact.

3.3 Ethical Issues

This project has several ethical issues that can be addressed by the IEEE Code of Conduct. Specifically, numbers 1, 2, 3, 5, 6, 7, and 9 are the most important items that pertain to the Infantry I.F.F. System the team is building this semester.

1. to accept responsibility in making decisions consistent with the safety, health, and welfare of the public, and to disclose promptly factors that might endanger the public or the environment;

2. to avoid real or perceived conflicts of interest whenever possible, and to disclose them to affected parties when they do exist;
3. to be honest and realistic in stating claims or estimates based on available data;
5. to improve the understanding of technology; its appropriate application, and potential consequences;
6. to maintain and improve our technical competence and to undertake technological tasks for others only if qualified by training or experience, or after full disclosure of pertinent limitations;
7. to seek, accept, and offer honest criticism of technical work, to acknowledge and correct errors, and to credit properly the contributions of others;
9. to avoid injuring others, their property, reputation, or employment by false or malicious action;

4 Cost and Schedule

4.1 Cost Analysis

The labor cost was calculated as follows:

$$\text{Labor Cost} = \text{Worker Salary (\$/hour)} \times 2.5 \times \text{Time (Hours) Invested In Project}$$

COMPILE PARTS LIST, SUM UP TOTAL, ADD TO LABOR COSTS - SAME AS PROPOSAL

4.2 Schedule

EDIT SCHEDULE CREATED IN PROPOSAL

References

- [1] “Mixed Signal Microcontroller MSP430F22x4,” Web, Texas Instruments, accessed February 2016. [Online]. Available: <http://www.ti.com/lit/ds/symlink/msp430f2274.pdf>
- [2] “Using the Real-Time Clock Library,” Web, Texas Instruments, accessed February 2016. [Online]. Available: <http://www.ti.com/lit/an/slaa076a/slaa076a.pdf>
- [3] “American National Standard for Safe Use of Lasers,” ANSI Z136.1-2000.

Appendix

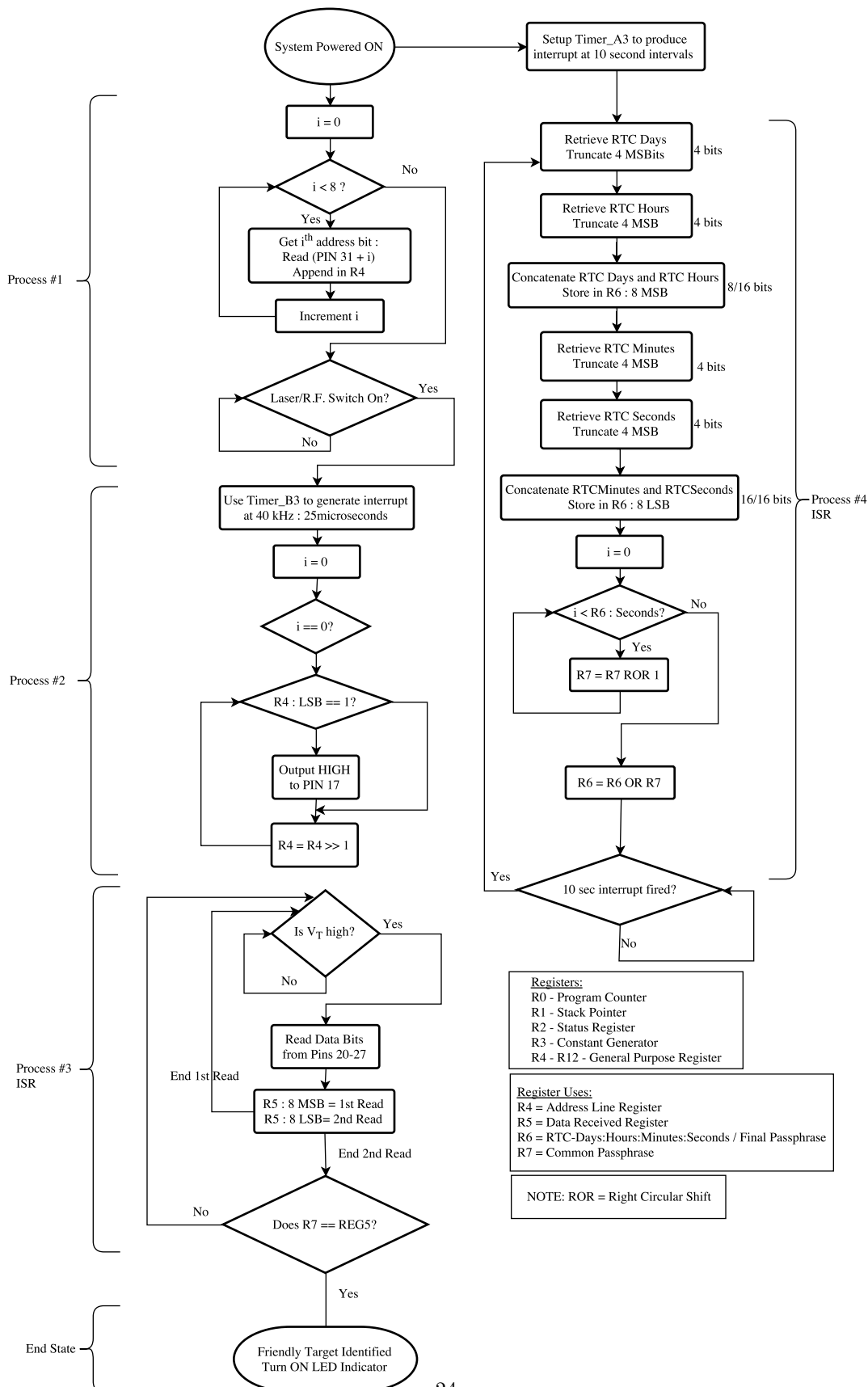


Figure 13: Flowchart for Functionality